

List of CCP' s Major Grades

Grade	NEMA/ ANSI	Characteristics	Application
CCP-3400 (AP)	FR-1	Punching improved type	◆ General application
CCP-3400 (ST)	FR-1	High anti-tracking complying with pattern method, 200V and IEC112 method, CTII ≥ 600V	◆ High humidity environment
CCP-3400 (RC)	FR-1	Excellent anti-silver migration	◆ Silver paste through hole
CCP-6400 (SM)	FR-1	Green laminate, low smell, high anti-tracking, complying with Pattern method, 200V and IEC112 method, CTII ≥ 600V	◆ High humidity environment
CCP-508	CEM-1	Composite epoxy laminate, General grade	◆ General application ◆ Wave solder process
CCP-508 (S)	CEM-1	Composite epoxy laminate, high anti-tracking, complying with IEC112 method, CTII ≥ 600V	◆ High humidity environment ◆ Wave solder process
CCP-508 (SW)	CEM-1	Composite epoxy laminate, high anti-tracking, complying with IEC112 method, CTII ≥ 600V	◆ High humidity environment ◆ Suitable in SMT process or HALS
CCP-518	CEM-1	Green laminate, Composite epoxy laminate, high anti-tracking, complying with IEC112 method, CTII ≥ 600V	◆ High humidity environment ◆ Wave solder process
CCP-308	CEM-3	Composite epoxy laminate, high anti-tracking, complying with IEC112 method, CTII ≥ 600V	◆ High humidity environment
CCP-308 (G)	CEM-3	Composite epoxy laminate, high anti-tracking, complying with IEC112 method, CTII ≥ 600V	◆ High humidity environment
CCP-308 (TC)	CEM-3	Composite epoxy laminate, excellent in thermal conductivity , complying with IEC112 method, CTII ≥ 600V	◆ LED monitor and lighting, electronic automobile, power supply circuit

The information contained herein is correct to the best of our knowledge. The recommendation or suggestion contained in this bulletin is made without guarantee or representation as to result. We suggest that you evaluate these recommendation and suggestions in your own laboratory prior to use. Our responsibility for claims arising from breach of warranty, negligence or otherwise is limited to the purchase price of the material.

Jan, 2017